











LM6152, LM6154

SNOS752E -MAY 1999-REVISED SEPTEMBER 2014

# LM6152/LM6154 Dual and Quad 75 MHz GBW Rail-to-Rail I/O Operational Amplifiers

#### **Features**

- At  $V_S = 5V$ , typical unless noted.
- Greater than Rail-to-rail Input CMVR -0.2 5V to 5.25 V
- Rail-to-rail Output Swing 0.01 V to 4.99 V
- Wide Gain-bandwidth 75 MHz @ 100 kHz
- Slew Rate
  - Small Signal 5 V/µs
  - Large Signal 45 V/µs
- Low Supply Current 1.4 mA/amplifier
- Wide Supply Range 2.7 V to 24 V
- Fast Settling Time of 1.1 µs for 2 V Step (to 0.01%)
- PSRR 91 dB
- CMRR 84 dB

### **Applications**

- Portable High Speed Instrumentation
- Signal Conditioning Amplifier/ADC Buffers
- **Barcode Scanners**

## 3 Description

patented circuit topologies, LM6152/LM6154 provides new levels of speed vs. power performance in applications where low voltage supplies or power limitations previously made compromise necessary. With only 1.4 mA/amplifier supply current, the 75 MHz gain bandwidth of this device supports new portable applications where higher power devices unacceptably drain battery life. The slew rate of the devices increases with increasing input differential voltage, thus allowing the device to handle capacitive loads while maintaining large signal amplitude.

The LM6152/LM6154 can be driven by voltages that exceed both power supply rails, thus eliminating concerns about exceeding the common-mode voltage range. The rail-to-rail output swing capability provides the maximum possible dynamic range at the output. This is particularly important when operating on low supply voltages.

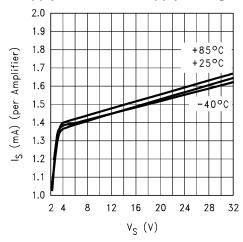
Operating on supplies from 2.7 V to over 24 V, the LM6152/LM6154 is excellent for a very wide range of applications, from battery operated systems with large bandwidth requirements to high speed instrumentation.

#### Device Information<sup>(1)</sup>

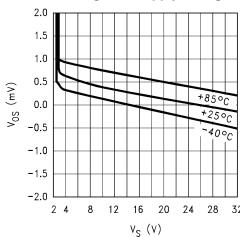
| PART NUMBER | PACKAGE   | BODY SIZE (NOM)     |  |  |
|-------------|-----------|---------------------|--|--|
| LM6152      | SOIC (8)  | 4.902 mm × 3.912 mm |  |  |
| LM6154      | SOIC (14) | 8.636 mm × 3.912 mm |  |  |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

#### Supply Current vs. Supply Voltage



#### Offset Voltage vs. Supply voltage





| Table of C | ontents |
|------------|---------|
|------------|---------|

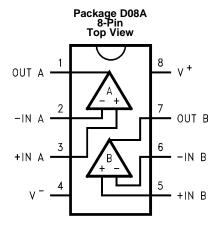
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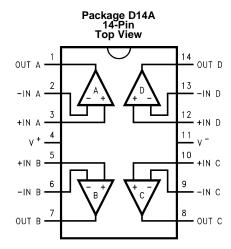
# 4 Revision History

| Changes from Revision D (March 2013) to Revision E  | Page |
|---|------|
| <ul> <li>Changed "Junction Temperature Range" to "Operating Temperature Range" and deleted "T<sub>J</sub>" in Recommended Operating Conditions</li> </ul> | 4    |
| Deleted T <sub>J</sub> = 25°C for Electrical Characteristics Tables   |      |
| Changes from Revision C (March 2013) to Revision D  | Page |
| Changed layout of National Data Sheet to TI format  | 15   |



# 5 Pin Configuration and Functions





#### **Pin Functions**

|                | PIN    |        |     |                         |
|----------------|--------|--------|-----|-------------------------|
| NAME           | LM6152 | LM6154 | 1/0 | DESCRIPTION             |
| NAME           | D08A   | D14A   |     |                         |
| -IN A          | 2      | 2      | I   | ChA Inverting Input     |
| +IN A          | 3      | 3      | I   | ChA Non-inverting Input |
| -IN B          | 6      | 6      | 1   | ChB Inverting Input     |
| +IN B          | 5      | 5      | I   | ChB Non-inverting Input |
| -IN C          |        | 9      | I   | ChC Inverting Input     |
| +IN C          |        | 10     | I   | ChC Non-inverting Input |
| -IN D          |        | 13     | 1   | ChD Inverting Input     |
| +IN D          |        | 12     | 1   | ChD Non-inverting Input |
| OUT A          | 1      | 1      | 0   | ChA Output              |
| OUT B          | 7      | 7      | 0   | ChB Output              |
| OUT C          |        | 8      | 0   | ChC Output              |
| OUT D          |        | 14     | 0   | ChD Output              |
| V <sup>-</sup> | 4      | 11     | I   | Negative Supply         |
| V <sup>+</sup> | 8      | 4      | I   | Positive Supply         |



## 6 Specifications

## 6.1 Absolute Maximum Ratings (1)(2)

|   | MIN | MAX   | UNIT |
|---|-----|---|------|
| Differential Input Voltage                        |     | ±15   | V    |
| Voltage at Input/Output Pin                       |     | (V <sup>+</sup> ) + 0.3<br>(V <sup>-</sup> ) -0.3 | V    |
| Supply Voltage (V <sup>+</sup> - V <sup>-</sup> ) |     | 35  | V    |
| Current at Input Pin                              |     | ±10   | mA   |
| Current at Output Pin (3)                         |     | ±25   | mA   |
| Current at Power Supply Pin                       |     | 50  | mA   |
| Lead Temperature (soldering, 10 sec)              |     | 260   | °C   |
| Junction Temperature (4)                          |     | 150   | °C   |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C.
- (4) The maximum power dissipation is a function of T<sub>J(MAX)</sub>, R<sub>BJA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is P<sub>D</sub> = (T<sub>J(MAX)</sub>-T<sub>A</sub>)/R<sub>BJA</sub>. All numbers apply for packages soldered directly into a PC board.

#### 6.2 Handling Ratings

|                    |                           |   | MIN | MAX  | UNIT |
|--------------------|---------------------------|---|-----|------|------|
| T <sub>stg</sub>   | Storage temperature range |   | -65 | +150 | °C   |
| V <sub>(ESD)</sub> | Electrostatic discharge   | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup> |     | 2500 | V    |

JEDEC document JEP155 states that 2500-V HBM allows safe manufacturing with a standard ESD control process. Human body model is 1.5 kΩ in series with 100 pF

## 6.3 Recommended Operating Conditions<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

| , , ,                                      |     |                       |      |
|--|-----|-----------------------|------|
|  | MIN | MAX                   | UNIT |
| Supply Voltage                             | 2.7 | ≤ V <sup>+</sup> ≤ 24 | V    |
| Operating Temperature Range, LM6152,LM6154 | 0   | +70                   | °C   |

<sup>(1)</sup> Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics.

#### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup>                           |         | D14A    | UNIT |
|---|---------|---------|------|
|   |         | 14 PINS | UNII |
| R <sub>θJA</sub> Junction-to-ambient thermal resistance | 193°C/W | 126°C/W | °C/W |

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.



## 6.5 5.0 V DC Electrical Characteristics

Unless otherwise specified, all limits are ensured for  $V^+ = 5.0V$ ,  $V^- = 0V$ ,  $V_{CM} = V_O = V^+/2$  and  $R_L > 1$  M $\Omega$  to  $V^+/2$ . **Boldface** limits apply at the temperature extremes.

|                   | PARAMETER                          | TEST CONDITIONS             | TYP <sup>(1)</sup> | LM6152AC<br>LIMIT <sup>(2)</sup> | LM6154BC<br>LM6152BC<br>LIMIT <sup>(2)</sup> | UNIT        |
|-------------------|------------------------------------|-----------------------------|--------------------|----------------------------------|--|-------------|
| V <sub>OS</sub>   | Input Offset Voltage               |                             | 0.54               | 2<br><b>4</b>                    | 5<br><b>7</b>                                | mV<br>max   |
| TCV <sub>OS</sub> | Input Offset Voltage Average Drift |                             | 10                 |                                  |  | μV/°C       |
| I <sub>B</sub>    | Input Bias Current                 | 0V ≤ V <sub>CM</sub> ≤ 5V   | 500<br><b>750</b>  | 980<br><b>1500</b>               | 980<br><b>1500</b>                           | nA max      |
| I <sub>OS</sub>   | Input Offset Current               |                             | 32<br><b>40</b>    | 100<br><b>160</b>                | 100<br><b>160</b>                            | nA max      |
| R <sub>IN</sub>   | Input Resistance, CM               | 0V ≤ V <sub>CM</sub> ≤ 4V   | 30                 |                                  |  | ΜΩ          |
| CMRR              | Common Mode Rejection Ratio        | 0V ≤ V <sub>CM</sub> ≤ 4V   | 94                 | 70                               | 70   | dB          |
|                   |                                    | 0V ≤ V <sub>CM</sub> ≤ 5V   | 84                 | 60                               | 60   | min         |
| PSRR              | Power Supply Rejection Ratio       | 5V ≤ V <sup>+</sup> ≤ 24V   | 91                 | 80                               | 80   | dB<br>min   |
| V <sub>CM</sub>   | Input Common-Mode Voltage Range    | Low                         | -0.25              | 0                                | 0  | V           |
|                   |                                    | High                        | 5.25               | 5.0                              | 5.0  | V           |
| A <sub>V</sub>    | Large Signal Voltage Gain          | $R_L = 10 \text{ k}\Omega$  | 214                | 50                               | 50   | V/mV<br>min |
| Vo                | Output Swing                       | $R_L = 100 \text{ k}\Omega$ | 0.006              | 0.02<br><b>0.03</b>              | 0.02<br><b>0.03</b>                          | V<br>max    |
|                   |                                    |                             | 4.992              | 4.97<br><b>4.96</b>              | 4.97<br><b>4.96</b>                          | V<br>min    |
|                   |                                    | $R_L = 2 k\Omega$           | 0.04               | 0.10<br><b>0.12</b>              | 0.10<br><b>0.12</b>                          | V<br>max    |
|                   |                                    |                             | 4.89               | 4.80<br><b>4.70</b>              | 4.80<br><b>4.70</b>                          | V<br>min    |
| I <sub>SC</sub>   | Output Short Circuit Current       | Sourcing                    | 0.0                | 3<br><b>2.5</b>                  | 3<br><b>2.5</b>                              | mA<br>min   |
|                   |                                    |                             | 6.2                | 27<br><b>17</b>                  | 27<br><b>17</b>                              | mA<br>max   |
|                   |                                    | Sinking                     | 46.0               | 7<br><b>5</b>                    | 7<br><b>5</b>                                | mA<br>min   |
|                   |                                    |                             | 16.9               | 40                               | 40   | mA<br>max   |
| Is                | Supply Current                     | Per Amplifier               | 1.4                | 2<br><b>2.25</b>                 | 2<br><b>2.25</b>                             | mA<br>max   |

Typical Values represent the most likely parametric norm. All limits are specified by testing or statistical analysis.



## 6.6 5.0 V AC Electrical Characteristics

Unless otherwise specified, all limits ensured for V<sup>+</sup> = 5.0V, V<sup>-</sup> = 0V,  $V_{CM} = V_O = V^+/2$  and  $R_L > 1$  M $\Omega$  to V<sup>+</sup>/2. **Boldface** limits apply at the temperature extremes.

|                | PARAMETER                    | TEST CONDITIONS  | TYP <sup>(1)</sup> | LM6152AC<br>LIMIT <sup>(2)</sup> | LM6154BC<br>LM6152BC<br>LIMIT <sup>(2)</sup> | UNIT               |
|----------------|------------------------------|--|--------------------|----------------------------------|--|--------------------|
| SR             | Slew Rate                    | $\pm 4V$ Step @ $V_S = \pm 6V$ , $R_S < 1 k\Omega$   | 30                 | 24<br><b>15</b>                  | 24<br><b>15</b>                              | V/µs<br>min        |
| GBW            | Gain-Bandwidth Product       | f = 100 kHz  | 75                 |                                  |  | MHz                |
|                | Amp-to-Amp Isolation         | $R_L = 10 \text{ k}\Omega$   | 125                |                                  |  | dB                 |
| e <sub>n</sub> | Input-Referred Voltage Noise | f = 1 kHz  | 9                  |                                  |  | nV/√ <del>Hz</del> |
| i <sub>n</sub> | Input-Referred Current Noise | f = 1 kHz  | 0.34               |                                  |  | pA/√ <del>Hz</del> |
| T.H.D          | Total Harmonic Distortion    | f = 100 kHz, R <sub>L</sub> = 10 kΩ<br>A <sub>V</sub> = -1, V <sub>O</sub> = 2.5 V <sub>PP</sub> | -65                |                                  |  | dBc                |
| ts             | Settling Time                | 2V Step to 0.01%   | 1.1                |                                  |  | μs                 |

Typical Values represent the most likely parametric norm. All limits are specified by testing or statistical analysis.

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#### 6.7 2.7 V DC Electrical Characteristics

Unless otherwise specified, all limits are ensured for  $V^+ = 2.7V$ ,  $V^- = 0V$ ,  $V_{CM} = V_O = V^+/2$  and  $R_L > 1$  M $\Omega$  to  $V^+/2$ . **Boldface** limits apply at the temperature extremes.

|                   | PARAMETER                          | TEST CONDITIONS            | TYP <sup>(1)</sup> | LM6152AC<br>LIMIT <sup>(2)</sup> | LM6154BC<br>LM6152BC<br>LIMIT <sup>(2)</sup> | UNIT      |
|-------------------|------------------------------------|----------------------------|--------------------|----------------------------------|--|-----------|
| Vos               | Input Offset Voltage               |                            | 0.8                | 2<br><b>5</b>                    | 5<br><b>8</b>                                | mV<br>max |
| TCV <sub>OS</sub> | Input Offset Voltage Average Drift |                            | 10                 |                                  |  | μV/°C     |
| $I_B$             | Input Bias Current                 |                            | 500                |                                  |  | nA        |
| Ios               | Input Offset Current               |                            | 50                 |                                  |  | nA        |
| $R_{\text{IN}}$   | Input Resistance, CM               | $0V \le V_{CM} \le 1.8V$   | 30                 |                                  |  | ΜΩ        |
| CMRR              | Common Mode Rejection Ratio        | $0V \le V_{CM} \le 1.8V$   | 88                 |                                  |  | ٩D        |
|                   |                                    | $0V \le V_{CM} \le 2.7V$   | 78                 |                                  |  | dB        |
| PSRR              | Power Supply Rejection Ratio       | $3V \le V^+ \le 5V$        | 69                 |                                  |  | dB        |
| $V_{CM}$          | Input Common-Mode Voltage Range    | Low                        | -0.25              | 0                                | 0  | V         |
|                   |                                    | High                       | 2.95               | 2.7                              | 2.7  | V         |
| $A_V$             | Large Signal Voltage Gain          | $R_L = 10 \text{ k}\Omega$ | 5.5                |                                  |  | V/mV      |
| Vo                | Output Swing                       | $R_L = 10 \text{ k}\Omega$ | 0.032              | 0.07<br><b>0.11</b>              | 0.07<br><b>0.11</b>                          | V<br>max  |
|                   |                                    |                            | 2.68               | 2.64<br><b>2.62</b>              | 2.64<br><b>2.62</b>                          | V<br>min  |
| I <sub>S</sub>    | Supply Current                     | Per Amplifier              | 1.35               |                                  |  | mA        |

<sup>(1)</sup> Typical Values represent the most likely parametric norm.

#### 6.8 2.7 V AC Electrical Characteristics

Unless otherwise specified, all limits are ensured for  $V^+ = 2.7V$ ,  $V^- = 0V$ ,  $V_{CM} = V_O = V^+/2$  and  $R_L > 1$  M $\Omega$  to  $V^+/2$ . **Boldface** limits apply at the temperature extremes.

| PARAMETER |                        | TEST CONDITIONS | TYP <sup>(1)</sup> | LM6152AC<br>LIMIT <sup>(2)</sup> | LM6154BC<br>LM6152BC<br>LIMIT <sup>(2)</sup> | UNIT |
|-----------|------------------------|-----------------|--------------------|----------------------------------|--|------|
| GBW       | Gain-Bandwidth Product | f = 100 kHz     | 80                 |                                  |  | MHz  |

<sup>(1)</sup> Typical Values represent the most likely parametric norm.

<sup>(2)</sup> All limits are specified by testing or statistical analysis.

<sup>(2)</sup> All limits are specified by testing or statistical analysis.



#### 6.9 24 V DC Electrical Characteristics

Unless otherwise specified, all limits are ensured for  $V^+ = 24V$ ,  $V^- = 0V$ ,  $V_{CM} = V_O = V^+/2$  and  $R_L > 1$  M $\Omega$  to  $V^+/2$ . **Boldface** limits apply at the temperature extremes.

|                   | PARAMETER                          | TEST CONDITIONS            | TYP <sup>(1)</sup> | LM6152AC<br>LIMIT <sup>(2)</sup> | LM6154BC<br>LM6152BC<br>LIMIT <sup>(2)</sup> | UNIT                |
|-------------------|------------------------------------|----------------------------|--------------------|----------------------------------|--|---------------------|
| V <sub>OS</sub>   | Input Offset Voltage               |                            | 0.3                | 2<br><b>4</b>                    | 7<br><b>9</b>                                | mV<br>max           |
| TCV <sub>OS</sub> | Input Offset Voltage Average Drift |                            | 10                 |                                  |  | μV/°C               |
| I <sub>B</sub>    | Input Bias Current                 |                            | 500                |                                  |  | nA                  |
| Ios               | Input Offset Current               |                            | 32                 |                                  |  | nA                  |
| R <sub>IN</sub>   | Input Resistance, CM               | $0V \le V_{CM} \le 23V$    | 60                 |                                  |  | $\text{Meg }\Omega$ |
| CMRR              | Common Mode Rejection Ratio        | $0V \le V_{CM} \le 23V$    | 94                 |                                  |  | dB                  |
|                   |                                    | $0V \le V_{CM} \le 24V$    | 84                 |                                  |  | uВ                  |
| PSRR              | Power Supply Rejection Ratio       | $0V \le V_{CM} \le 24V$    | 95                 |                                  |  | dB                  |
| V <sub>CM</sub>   | Input Common-Mode Voltage Range    | Low                        | -0.25              | 0                                | 0  | V                   |
|                   |                                    | High                       | 24.25              | 24                               | 24   | V                   |
| A <sub>V</sub>    | Large Signal Voltage Gain          | $R_L = 10 \text{ k}\Omega$ | 55                 |                                  |  | V/mV                |
| Vo                | Output Swing                       | $R_L = 10 \text{ k}\Omega$ | 0.044              | 0.075<br><b>0.090</b>            | 0.075<br><b>0.090</b>                        | V<br>max            |
|                   |                                    |                            | 23.91              | 23.8<br><b>23.7</b>              | 23.8<br><b>23.7</b>                          | V<br>min            |
| Is                | Supply Current                     | Per Amplifier              | 1.6                | 2.25<br><b>2.50</b>              | 2.25<br><b>2.50</b>                          | mA<br>max           |

<sup>(1)</sup> Typical Values represent the most likely parametric norm.

#### 6.10 24 V AC Electrical Characteristics

Unless otherwise specified, all limits are ensured for  $V^+ = 24V$ ,  $V^- = 0V$ ,  $V_{CM} = V_O = V^+/2$  and  $R_L > 1$  M $\Omega$  to  $V^+/2$ . **Boldface** limits apply at the temperature extremes.

| PARAMETER |                        | TEST CONDITIONS | TYP <sup>(1)</sup> | LM6152AC<br>LIMIT <sup>(2)</sup> | LM6154BC<br>LM6152BC<br>LIMIT <sup>(2)</sup> | UNIT |
|-----------|------------------------|-----------------|--------------------|----------------------------------|--|------|
| GBW       | Gain-Bandwidth Product | f = 100 kHz     | 80                 |                                  |  | MHz  |

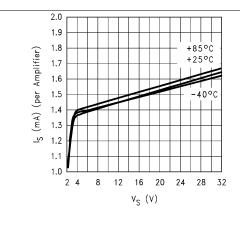
<sup>(1)</sup> Typical Values represent the most likely parametric norm.

<sup>(2)</sup> All limits are specified by testing or statistical analysis.

<sup>(2)</sup> All limits are specified by testing or statistical analysis.



### **6.11 Typical Performance Characteristics**



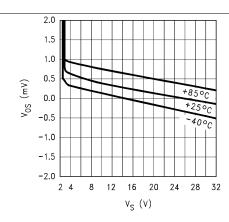
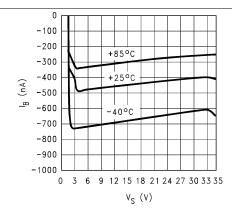


Figure 1. Supply Current vs. Supply Voltage





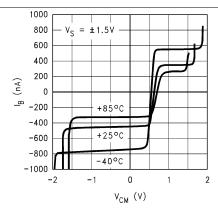
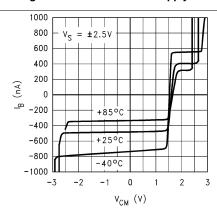


Figure 3. Bias Current vs. Supply voltage





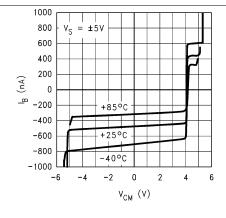


Figure 5. Bias Current vs.  $V_{\text{CM}}$ 

Figure 6. Bias Current vs.  $V_{\text{CM}}$ 

# STRUMENTS

### **Typical Performance Characteristics (continued)**

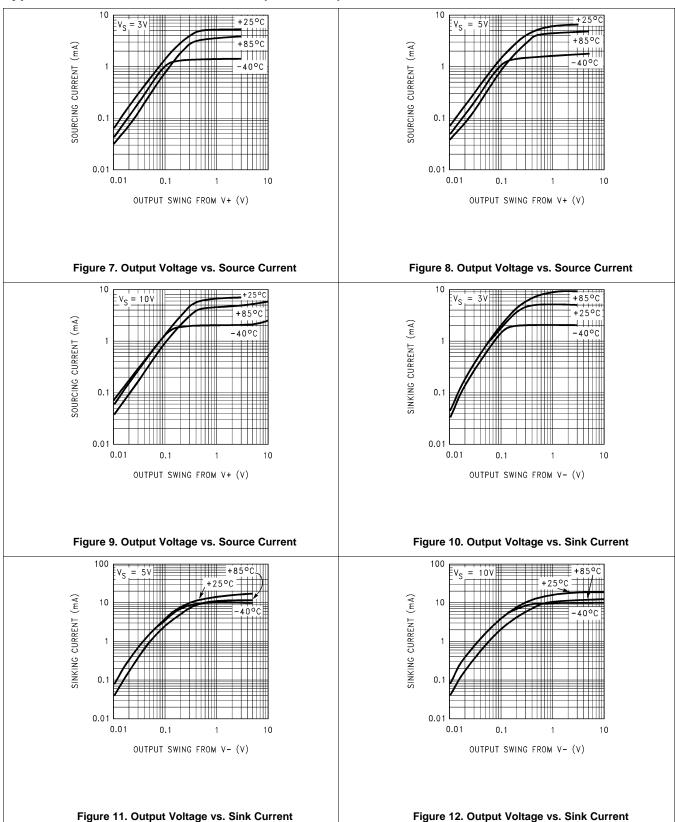
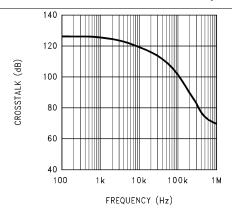


Figure 11. Output Voltage vs. Sink Current

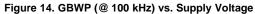


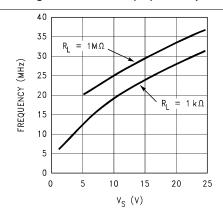
## **Typical Performance Characteristics (continued)**



60 50 40 40 30 R<sub>L</sub> = 1 kΩ 10 0 5 10 15 20 25 V<sub>S</sub> (V)

Figure 13. Crosstalk (dB) vs. Frequency





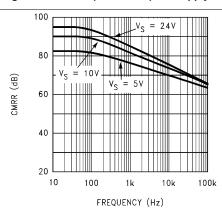
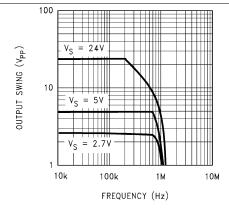


Figure 15. Unity Gain Frequency vs. Supply Voltage for Various Loads





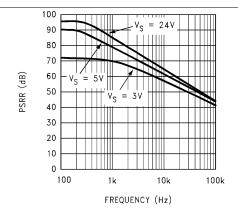


Figure 17. Voltage Swing vs. Frequency  $(C_L = 100 pF)$ 

Figure 18. PSRR vs. Frequency

# TEXAS INSTRUMENTS

## **Typical Performance Characteristics (continued)**

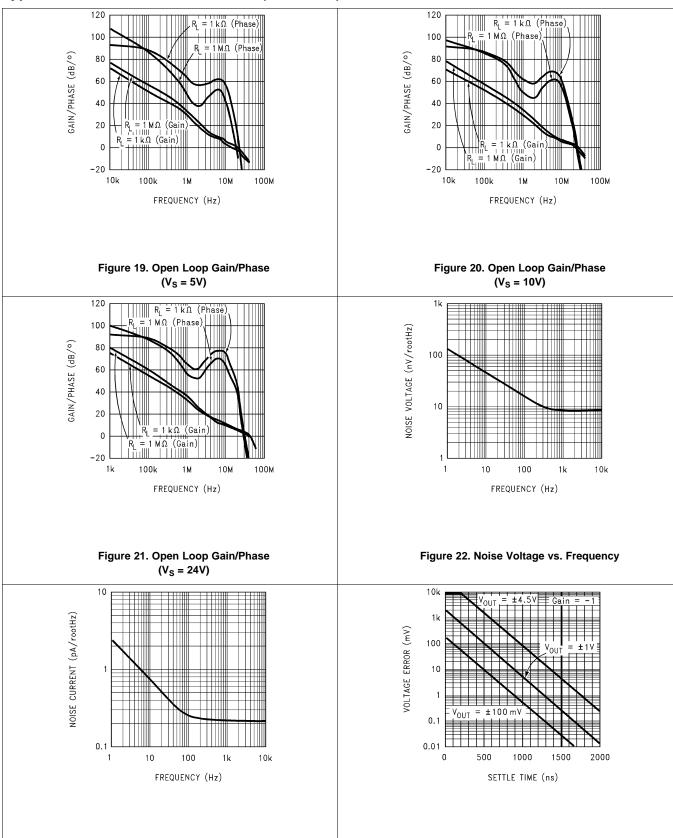
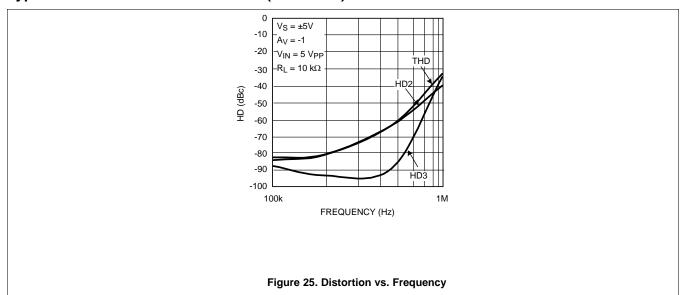


Figure 23. Noise Current vs. Frequency

Figure 24. Voltage Error vs. Settle Time



## **Typical Performance Characteristics (continued)**





## 7 Application and Implementation

The LM6152/LM6154 is ideally suited for operation with about 10 k $\Omega$  (Feedback Resistor, R<sub>F</sub>) between the output and the negative input terminal.

With  $R_F$  set to this value, for most applications requiring a close loop gain of 10 or less, an additional small compensation capacitor ( $C_F$ ) (see Figure 26) is recommended across  $R_F$  in order to achieve a reasonable overshoot (10%) at the output by compensating for stray capacitance across the inputs.

The optimum value for  $C_F$  can best be established experimentally with a trimmer cap in place since its value is dependant on the supply voltage, output driving load, and the operating gain. Below, some typical values used in an inverting configuration and driving a 10 k $\Omega$  load have been tabulated for reference:

V<sub>S</sub> Volts C<sub>F</sub> pF BW (-3 dB) **GAIN** MHz -1 4 5.6 3 -10 6.8 1.97 0.797 -100 None -1 2.2 6.6 -10 4.7 2.2 24 -100 None 0.962

Table 1. Typical BW (-3 dB) at Various Supply Voltage and Gains

In the non-inverting configuration, the LM6152/LM6154 can be used for closed loop gains of +2 and above. In this case, also, the compensation capacitor ( $C_F$ ) is recommended across  $R_F$  (= 10 k $\Omega$ ) for gains of 10 or less.

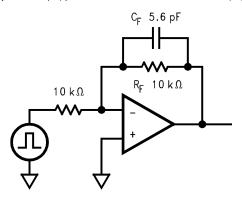


Figure 26. Typical Inverting Gain Circuit  $A_V = -1$ 

Because of the unique structure of this amplifier, when used at low closed loop gains, the realizable BW will be much less than the GBW product would suggest.

The LM6152/LM6154 brings a new level of ease of use to op amp system design.

The greater than rail-to-rail input voltage range eliminates concern over exceeding the common-mode voltage range. The rail-to-rail output swing provides the maximum possible dynamic range at the output. This is particularly important when operating on low supply voltages.

The high gain-bandwidth with low supply current opens new battery powered applications where higher power consumption previously reduced battery life to unacceptable levels.

The ability to drive large capacitive loads without oscillating functional removes this common problem.

To take advantage of these features, some ideas should be kept in mind.

The LM6152/LM6154, capacitive loads do not lead to oscillations, in all but the most extreme conditions, but they will result in reduced bandwidth. They also cause increased settling time.



Unlike most bipolar op amps, the unique phase reversal prevention/speed-up circuit in the input stage, causes the slew rate to be very much a function of the input pulse amplitude. This results in a 10 to 1 increase in slew rate when the differential input signal increases. Large fast pulses will raise the slew-rate to more than 30 V/µs.

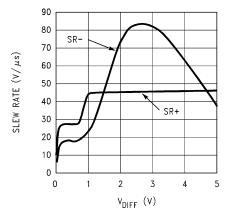


Figure 27. Slew Rate vs. VDIFF

The speed-up action adds stability to the system when driving large capacitive loads.

A conventional op amp exhibits a fixed maximum slew-rate even though the differential input voltage rises due to the lagging output voltage. In the LM6152/LM6154, increasing lag causes the differential input voltage to increase but as it does, the increased slew-rate keeps the output following the input much better. This effectively reduces phase lag. As a result, the LM6152/LM6154 can drive capacitive loads as large as 470 pF at gain of 2 and above, and not oscillate.

Capacitive loads decrease the phase margin of all op amps. This can lead to overshoot, ringing and oscillation. This is caused by the output resistance of the amplifier and the load capacitance forming an R-C phase shift network. The LM6152/6154 senses this phase shift and partly compensates for this effect.



### 8 Device and Documentation Support

#### 8.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 2. Related Links

| PARTS  | PRODUCT FOLDER | SAMPLE & BUY TECHNICAL DOCUMENTS |            | TOOLS &<br>SOFTWARE | SUPPORT & COMMUNITY |  |
|--------|----------------|----------------------------------|------------|---------------------|---------------------|--|
| LM6152 | Click here     | Click here                       | Click here | Click here          | Click here          |  |
| LM6154 | Click here     | Click here                       | Click here | Click here          | Click here          |  |

#### 8.2 Trademarks

All trademarks are the property of their respective owners.

#### 8.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 8.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 9 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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#### PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan            | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| LM6152ACM        | NRND       | SOIC         | D                  | 8    | 95             | Non-RoHS<br>& Green | Call TI                       | Level-1-235C-UNLIM | 0 to 70      | LM61<br>52ACM           |         |
| LM6152ACM/NOPB   | ACTIVE     | SOIC         | D                  | 8    | 95             | RoHS & Green        | SN                            | Level-1-260C-UNLIM | 0 to 70      | LM61<br>52ACM           | Samples |
| LM6152ACMX/NOPB  | ACTIVE     | SOIC         | D                  | 8    | 2500           | RoHS & Green        | SN                            | Level-1-260C-UNLIM | 0 to 70      | LM61<br>52ACM           | Samples |
| LM6152BCM/NOPB   | ACTIVE     | SOIC         | D                  | 8    | 95             | RoHS & Green        | SN                            | Level-1-260C-UNLIM | 0 to 70      | LM61<br>52BCM           | Samples |
| LM6152BCMX/NOPB  | ACTIVE     | SOIC         | D                  | 8    | 2500           | RoHS & Green        | SN                            | Level-1-260C-UNLIM | 0 to 70      | LM61<br>52BCM           | Samples |
| LM6154BCM        | NRND       | SOIC         | D                  | 14   | 55             | Non-RoHS<br>& Green | Call TI                       | Level-1-235C-UNLIM | 0 to 70      | LM6154BCM               |         |
| LM6154BCM/NOPB   | ACTIVE     | SOIC         | D                  | 14   | 55             | RoHS & Green        | SN                            | Level-1-260C-UNLIM | 0 to 70      | LM6154BCM               | Samples |
| LM6154BCMX/NOPB  | ACTIVE     | SOIC         | D                  | 14   | 2500           | RoHS & Green        | SN                            | Level-1-260C-UNLIM | 0 to 70      | LM6154BCM               | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



## **PACKAGE OPTION ADDENDUM**

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## **PACKAGE MATERIALS INFORMATION**

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## TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device          | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| LM6152ACMX/NOPB | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.5        | 5.4        | 2.0        | 8.0        | 12.0      | Q1               |
| LM6152BCMX/NOPB | SOIC            | D                  | 8  | 2500 | 330.0                    | 12.4                     | 6.5        | 5.4        | 2.0        | 8.0        | 12.0      | Q1               |
| LM6154BCMX/NOPB | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.35       | 2.3        | 8.0        | 16.0      | Q1               |

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\*All dimensions are nominal

| 4 | 7 III GITTIGITOTO GITO TIGITIITIGI |              |                 |      |      |             |            |             |
|---|------------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
|   | Device                             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|   | LM6152ACMX/NOPB                    | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
|   | LM6152BCMX/NOPB                    | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
|   | LM6154BCMX/NOPB                    | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 35.0        |

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#### **TUBE**



\*All dimensions are nominal

| All difficultions are norminal |                   |      |      |     |        |        |        |        |
|--------------------------------|-------------------|------|------|-----|--------|--------|--------|--------|
| Device                         | vice Package Name |      | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
| LM6152ACM                      | D                 | SOIC | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM6152ACM                      | D                 | SOIC | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM6152ACM/NOPB                 | D                 | SOIC | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM6152BCM/NOPB                 | D                 | SOIC | 8    | 95  | 495    | 8      | 4064   | 3.05   |
| LM6154BCM                      | D                 | SOIC | 14   | 55  | 495    | 8      | 4064   | 3.05   |
| LM6154BCM                      | D                 | SOIC | 14   | 55  | 495    | 8      | 4064   | 3.05   |
| LM6154BCM/NOPB                 | D                 | SOIC | 14   | 55  | 495    | 8      | 4064   | 3.05   |

# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



# D (R-PDSO-G14)

# PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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